Features
- Interdigitated amplifying gates
- Fast turn-on and high di/dt
- Low switching losses

Typical Applications
- Inductive heating
- Electronic welders
- Self-commutated inverters

$I_{T(AV)}$	**750A**
V_{DRM}/V_{RRM}	**800~1800V**
t_q	**18~50μs**
I_{TSM}	**9.5kA**
I^2t	**451 10^3A^2S**

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T_j(℃)	VALUE			UNIT
				Min	Type	Max	
$I_{T(AV)}$	Mean on-state current	180° half sine wave 50Hz Double side cooled, T_C=55℃	125			750	A
V_{DRM} V_{RRM}	Repetitive peak off-state voltage Repetitive peak reverse voltage	tp=10ms	125	800		1800	V
I_{DRM} I_{RRM}	Repetitive peak current	at V_{DRM} at V_{RRM}	125			40	mA
I_{TSM}	Surge on-state current	10ms half sine wave V_R=0.6V_{RRM}	125			9.5	kA
I^2t	I^2t for fusing coordination					451	A^2s*10^3
V_{TO}	Threshold voltage		125			1.40	V
r_T	On-state slope resistance					0.68	mΩ
V_{TM}	Peak on-state voltage	I_{TM}=1400A, F=15kN	125			2.35	V
dv/dt	Critical rate of rise of off-state voltage	V_{DM}=0.67V_{DRM}	125			500	V/μs
di/dt	Critical rate of rise of on-state current	V_{DM}= 67%V_{DRM} to 1000A, Gate pulse t_r ≤0.5μs I_{GM}=1.5A	125			1200	A/μs
Q_{rr}	Recovery charge	I_{TM}=1000A,tp=2000μs, di/dt=-60A/μs,V_R=50V	125		460		μC
tq	Circuit commutated turn-off time	I_{TM}=1000A,tp=2000μs, V_R =50V dv/dt=30V/μs ,di/dt=-60A/μs	125	18		50	μs
I_{GT}	Gate trigger current	V_A=12V, I_A=1A	25	40		250	mA
V_{GT}	Gate trigger voltage			0.9		2.5	V
I_H	Holding current			20		400	mA
V_{GD}	Non-trigger gate voltage	V_{DM}=67%V_{DRM}	125	0.3			V
$R_{th(j-c)}$	Thermal resistance Junction to case	DC, double side cooled Clamping force 15kN				0.035	℃/W
$R_{th(c-h)}$	Thermal resistance case to heat sink					0.008	
F_m	Mounting force			10		20	kN
T_{stg}	Stored temperature			-40		140	℃
W_t	Weight				240		g
Outline	P08						

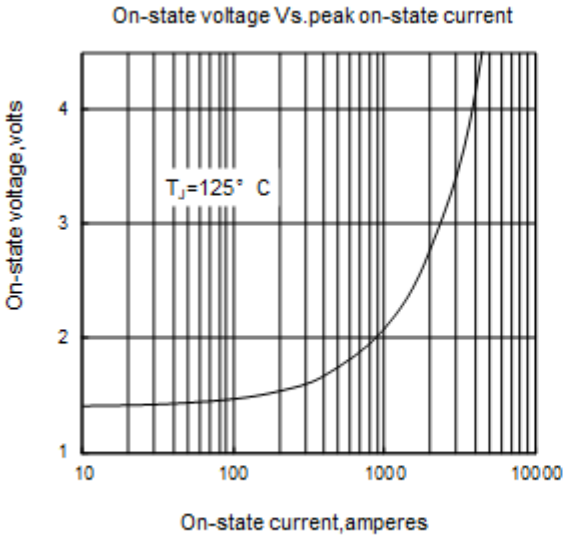

Fig1

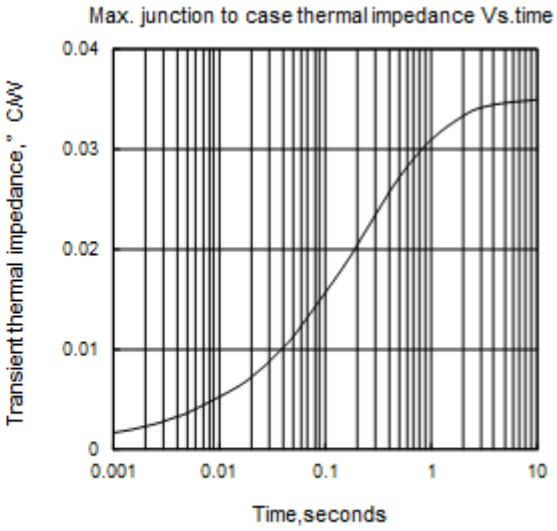

Fig2

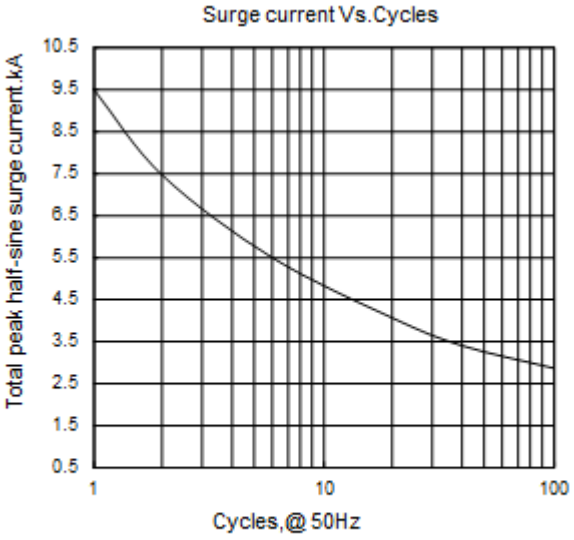

Fig3

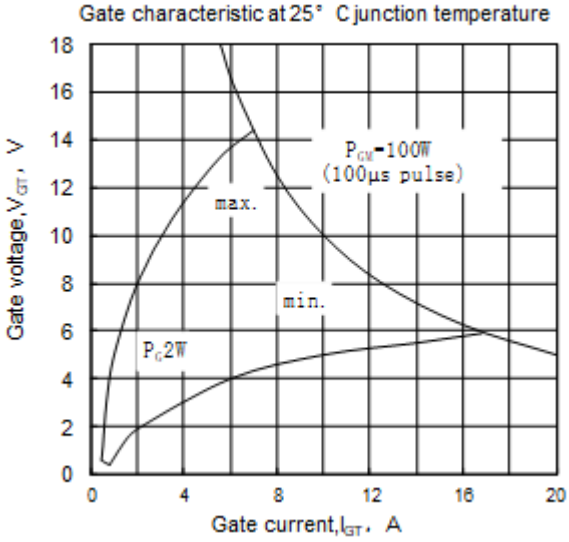

Fig4

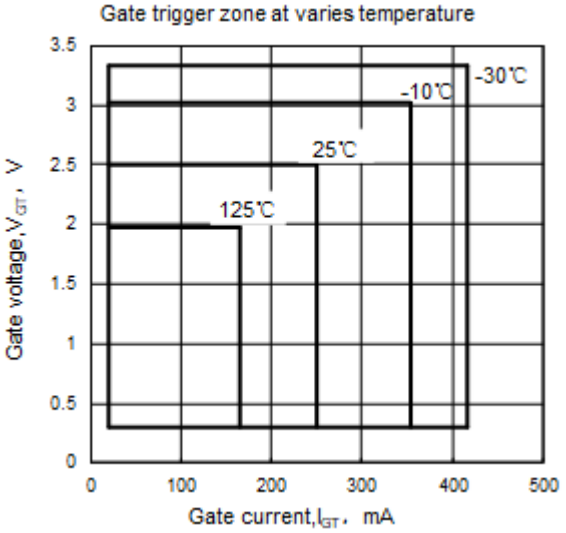

Fig5